

Dual N-Channel Enhancement Power Mosfet

General Description

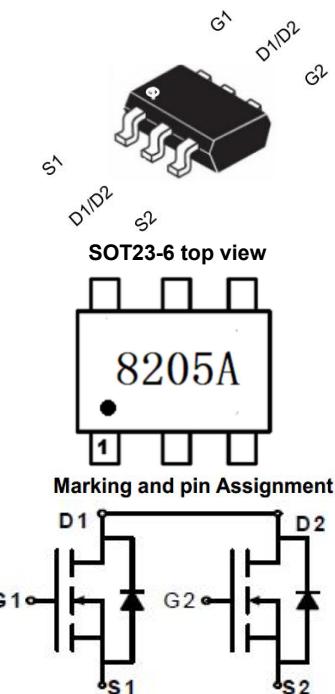
These This device uses advanced trench technology to provide excellent Rds(on),low gate charge and operation with gate voltages as low as 2.5V.

Features

- V_{DS} = 20V, I_D = 6A
- R_{DS(ON)}, 19.5m Ω (Typ) @ V_{GS} = 4.5V
- R_{DS(ON)}, 25m Ω (Typ) @ V_{GS} = 2.5V
- Trench Power Technology
- Low RDS(ON)
- Low Gate Charge
- Optimized for Fast-switching Applications

Application

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

**Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
8205A	8205A	SOT23-6	233mm	8mm	3000

Absolute Maximum Ratings(TA=25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DS}	20	V
Gate-Source Voltage		V _{GS}	±10	V
Drain Current-Continuous ^{Note3}	TC=25°C	I _D	6	A
	TC=70°C		4.8	A
Drain Current-Pulsed ^{Note1}		I _{DM}	24	A
Avalanche Energy ^{Note4}		E _{AS}	7.4	mJ
Maximum Power Dissipation	TC=25°C	P _D	1.5	W
Storage Temperature Range		T _{STG}	-55 to +150	°C
Operating Junction Temperature Range		T _J	-55 to +150	°C

Thermal Resistance

Parameter	Symbol	Min.	Typ.	Max	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	-	14.4	-	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	-	83	-	°C/W

Electrical Characteristics(TJ=25°C unless otherwise noted)

OFF CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _{DS} =250uA	20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V	-	-	1	uA
Gate-Body Leakage	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±100	nA

ON CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} ,I _{DS} =250uA	0.5	0.7	1.2	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V,I _{DS} =3A	-	19.5	25	mΩ
		V _{GS} =2.5V,I _{DS} =3A	-	25	31.5	

DYNAMIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input Capacitance	C _{iss}	V _{DS} =10V, V _{GS} = 0V, f=1MHz	-	466	-	pF
Output Capacitance	C _{oss}		-	65	-	
Reverse Transfer Capacitance	C _{rss}		-	58	-	

SWITCHING CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Turn-On Delay Time	T _{d(on)}	V _{GS} =4.5V,V _{DS} =10V, R _{GEN} =2.5Ω I _D =6A	-	15	-	ns
Rise Time	t _r		-	17	-	
Turn-Off Delay Time	T _{d(off)}		-	42	-	
Fall Time	t _f		-	10	-	
Total Gate Charge at 10V	Q _g	V _{DS} =10V,I _{DS} =6A, V _{GS} =10V	-	5.7	-	nC
Gate to Source Gate Charge	Q _{gs}		-	0.8	-	
Gate to Drain"Miller"Charge	Q _{gd}		-	1.4	-	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _{DS} =6A	-	-	1.2	V

Notes:

- 1: Repetitive rating, pulse width limited by maximum junction temperature.
- 2: Surface mounted on FR4 Board, t≤10sec.
- 3: Pulse width ≤ 300μs, duty cycle ≤ 2%.
- 4: EAS condition: VDD=20V, VG=10V, V_{GATE}=20V, Start TJ=25°C.

Typical Performance Characteristics

Figure 1. Output Characteristics

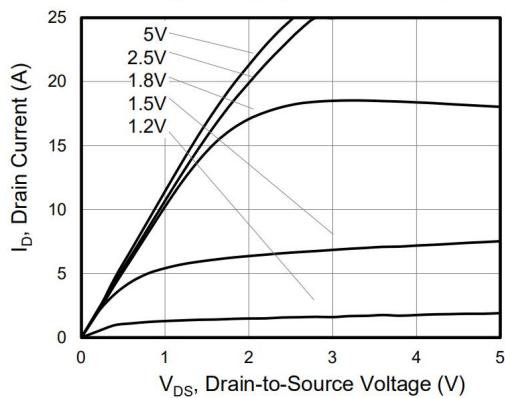


Figure 2. Transfer Characteristics

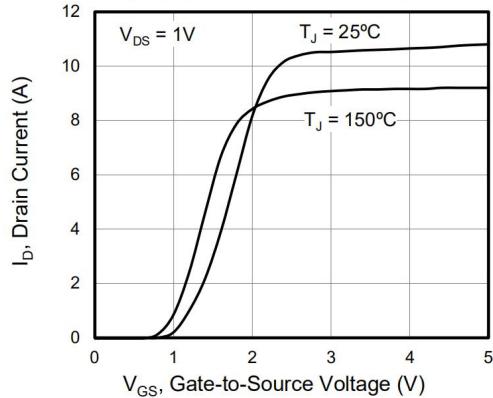


Figure 3. On-Resistance vs. Drain Current

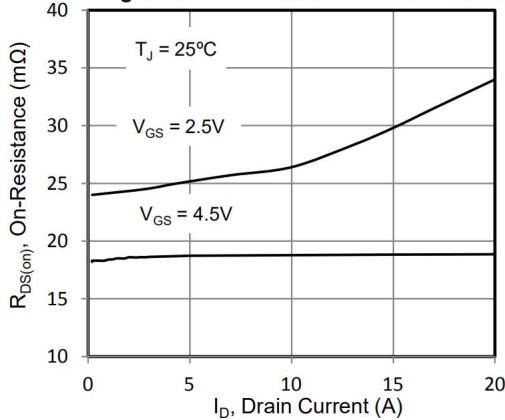


Figure 4. Capacitance

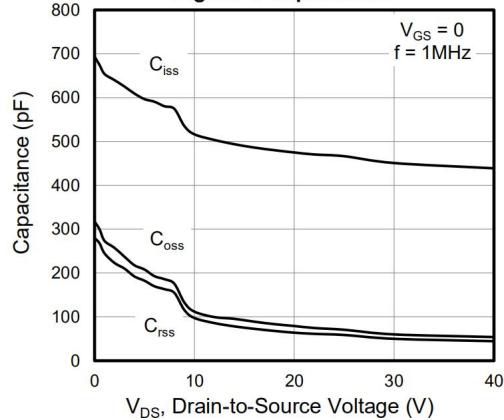


Figure 5. Gate Charge

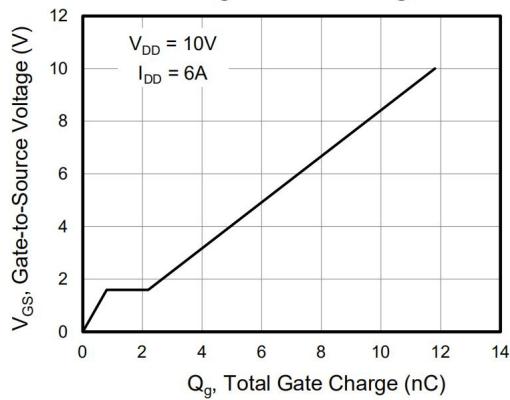


Figure 6. Body Diode Forward Voltage

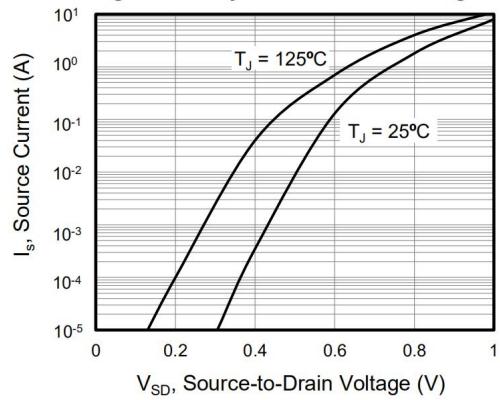


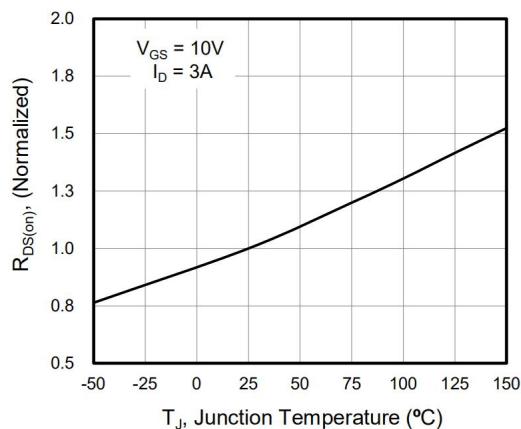
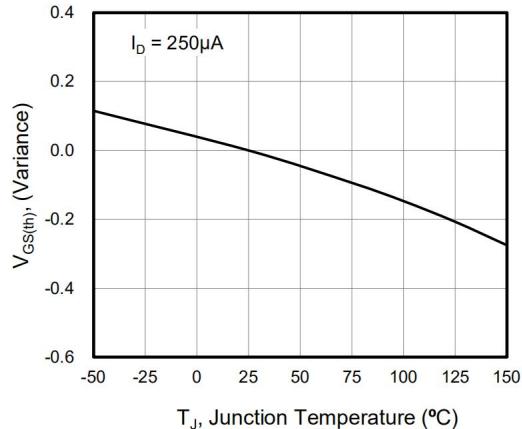
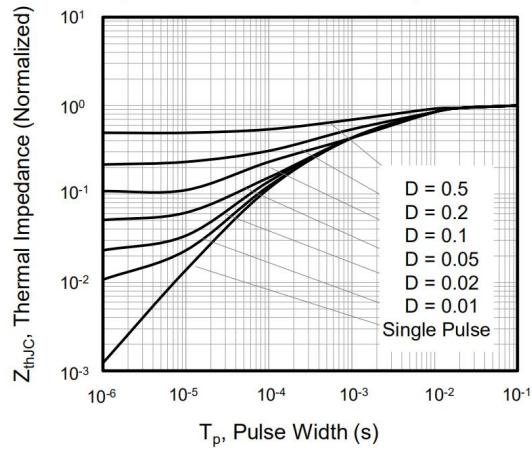
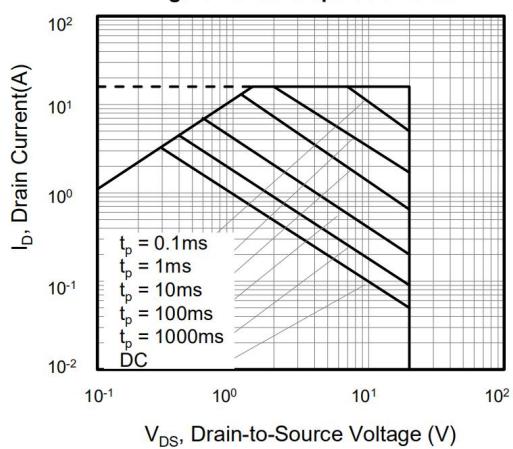
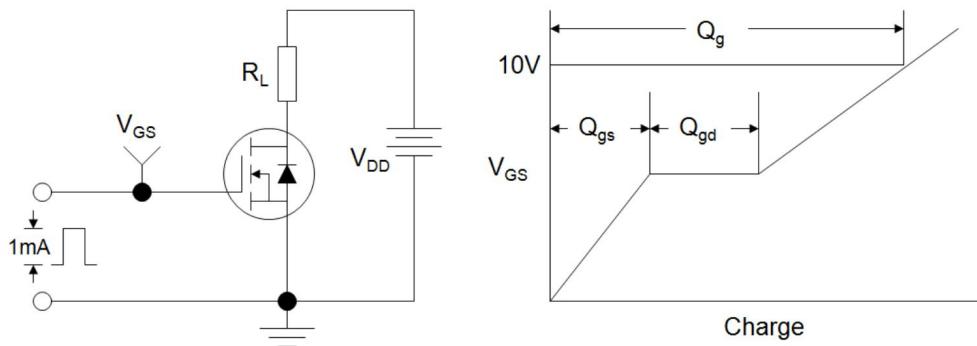
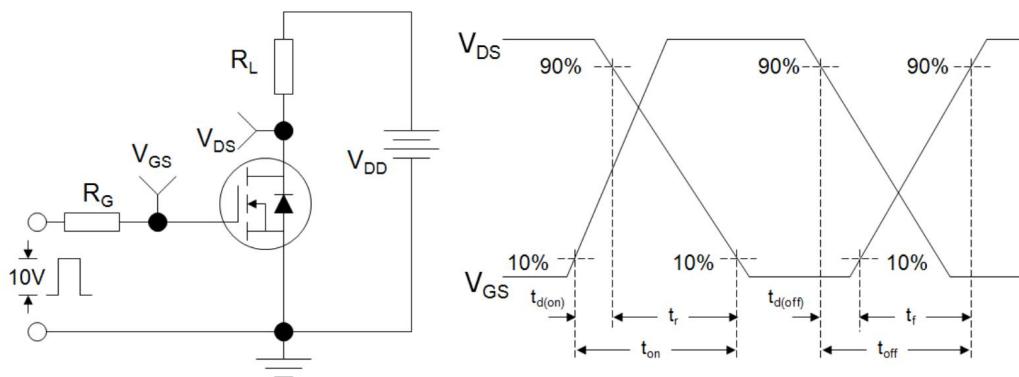
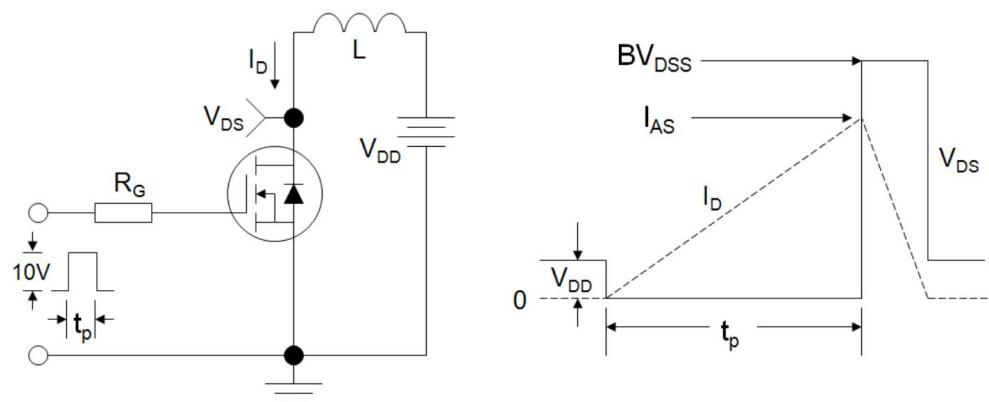
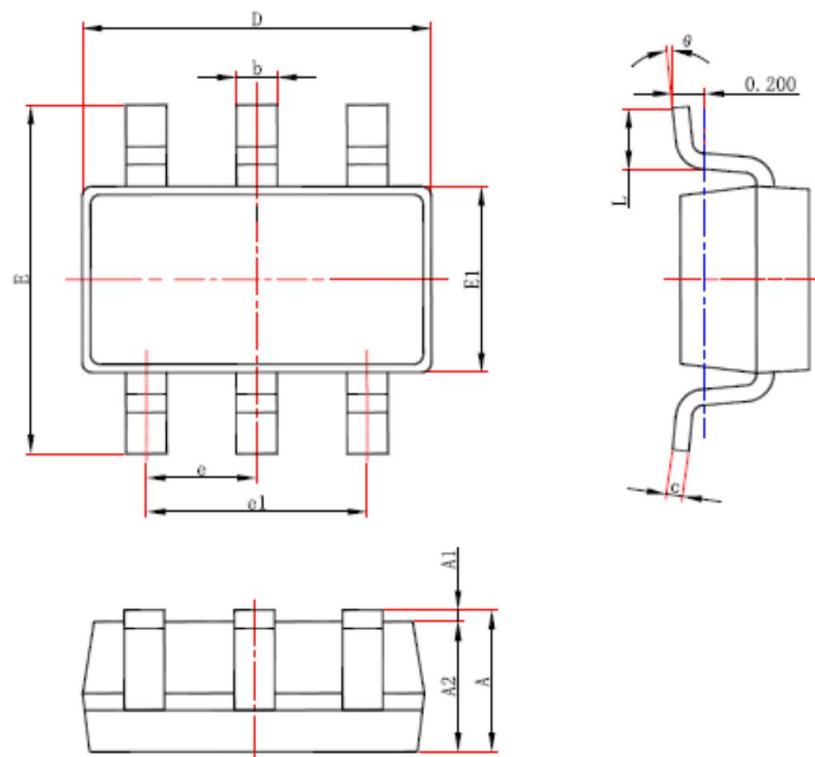
Figure 7. On-Resistance vs. Junction Temperature**Figure 8. Threshold Voltage vs. Junction Temperature****Figure 9. Transient Thermal Impedance****Figure 10. Safe operation area**

Figure A: Gate Charge Test Circuit and Waveform**Figure B: Resistive Switching Test Circuit and Waveform****Figure C: Unclamped Inductive Switching Test Circuit and Waveform**

SOT23-6



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°